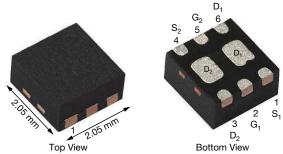
Vishay Siliconix

# **Dual N-Channel 20 V (D-S) MOSFET**

PRODUCT SUMMARY								
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A)	Q <sub>g</sub> (TYP.)					
20	0.034 at V <sub>GS</sub> = 4.5 V	4.5 <sup>a</sup>						
	0.037 at V <sub>GS</sub> = 3.7 V	4.5 <sup>a</sup>	5.4 nC					
	0.045 at V <sub>GS</sub> = 2.5 V	4.5 <sup>a</sup>						

#### PowerPAK® SC-70-6L Dual



Marking Code: CK Ordering Information:

SiA936EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- TrenchFET® Power MOSFET
- Thermally enhanced PowerPAK® SC-70 package
  - Small footprint area
  - Low on-resistance
- Typical ESD protection: 2000 V (HBM)
- 100 % R<sub>g</sub> tested

 Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

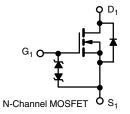


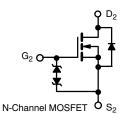
RoHS COMPLIANT

HALOGEN FREE

#### **APPLICATIONS**

- Portable devices such as smart phones, tablet PCs and mobile computing
  - Load switch
  - DC/DC converter
  - Power management





<b>ABSOLUTE MAXIMUM RATING</b>	<b>S</b> (T <sub>A</sub> = 25 °C, u	nless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	20	V	
Gate-Source Voltage		$V_{GS}$	± 12	V	
	T <sub>C</sub> = 25 °C		4.5 <sup>a</sup>		
Continuous Dunis Comment /T. 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	4.5 <sup>a</sup>		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		4.5 <sup>a,b,c</sup>		
	T <sub>A</sub> = 70 °C	1	4.5 <sup>a,b,c</sup>	Α	
Pulsed Drain Current (t = 100 μs)		I <sub>DM</sub>	20		
$T_{C} =$			4.5 <sup>a</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.6 <sup>b,c</sup>		
	T <sub>C</sub> = 25 °C		7.8		
Mariana Dama Dissination	T <sub>C</sub> = 70 °C	5	5		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.9 <sup>b,c</sup>	W	
	T <sub>A</sub> = 70 °C	1	1.2 <sup>b,c</sup>		
Operating Junction and Storage Temperatur	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	00		
Soldering Recommendations (Peak Tempera	ature) <sup>d,e</sup>		260	°C	

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
		$R_{thJA}$	52	65	°C/W				
Maximum Junction-to-Case (Drain)	ion-to-Case (Drain) Steady State		12.5	16	C/VV				

### Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state condition is 110 °C/W.

# Vishay Siliconix

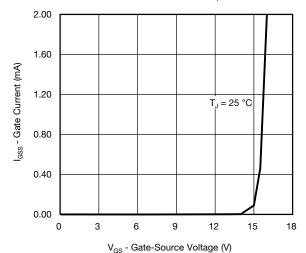
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A		24			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		-3.2		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.3	V	
Octo Course Leglings		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 0.2		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 10		
Zara Cata Valtaga Dyain Current		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$		0.027	0.034	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 3.7 V, I <sub>D</sub> = 3 A		0.029	0.037		
		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 3 A		0.035	0.045		
Forward Transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 4 A		22		S	
Dynamic <sup>b</sup>	•		,				
Total Cata Chausa	Qg	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A		11.3	17	nC	
Total Gate Charge				5.4	8.1		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 6 \text{ A}$		1			
Gate-Drain Charge	$Q_{gd}$			1.3			
Gate Resistance			0.4	1.8	3.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10	20		
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V, R}_{L} = 2 \Omega$		32	65		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		22	45		
Fall Time	t <sub>f</sub>			10	20		
Turn-On Delay Time	t <sub>d(on)</sub>			10	20	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{L} = 2 \Omega$		10	20		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		20	40	1	
Fall Time $t_{\rm f}$				10	20		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			4.5	Τ.	
Pulse Diode Forward Current	I <sub>SM</sub>				20	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V		0.84	1.2	V	
Body Diode Reverse Recovery Time t <sub>rr</sub>				10	20	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			4	10	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		6		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	1		4			

#### Notes

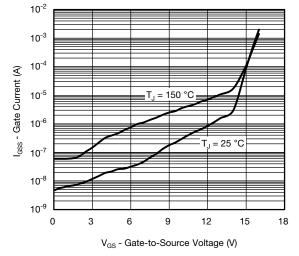
- a. Pulse test; pulse width  $\leq 300~\mu s,\,duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

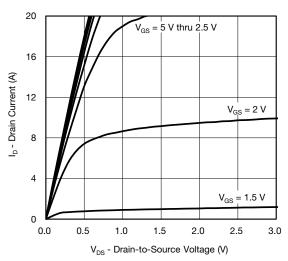




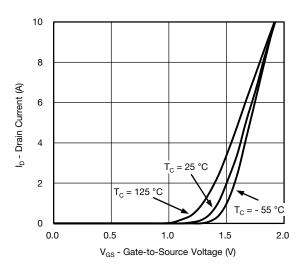
Gate Current vs. Gate-Source Voltage



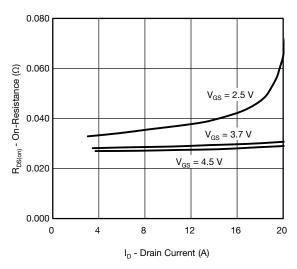
Gate Current vs. Gate-Source Voltage



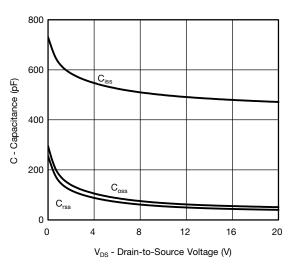
**Output Characteristics** 



**Transfer Characteristics** 

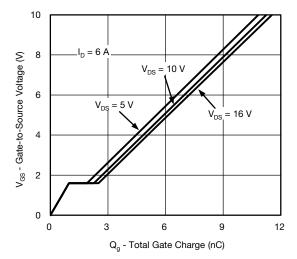


On-Resistance vs. Drain Current and Gate Voltage

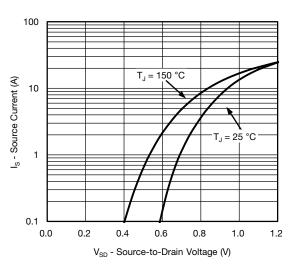


Capacitance

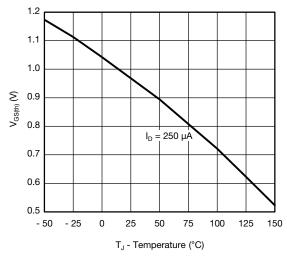




#### **Gate Charge**

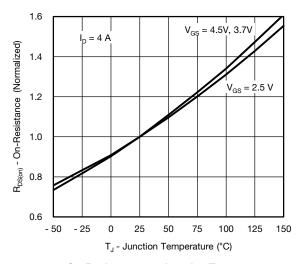


Source-Drain Diode Forward Voltage

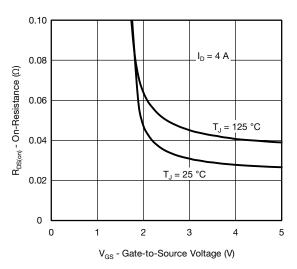


**Threshold Voltage** 

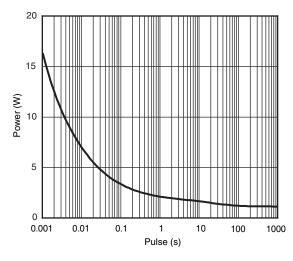
S13-2624-Rev. A, 23-Dec-13



On-Resistance vs. Junction Temperature

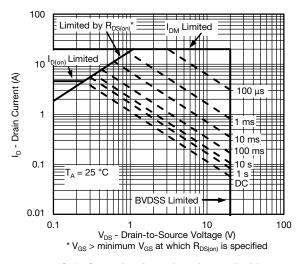


On-Resistance vs. Gate-to-Source Voltage



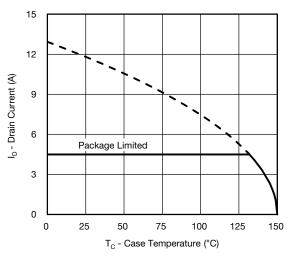
Single Pulse Power (Junction-to-Ambient)

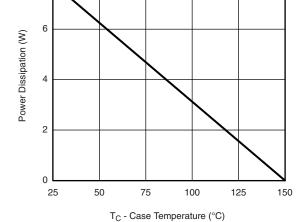




Safe Operating Area, Junction-to-Ambient

8



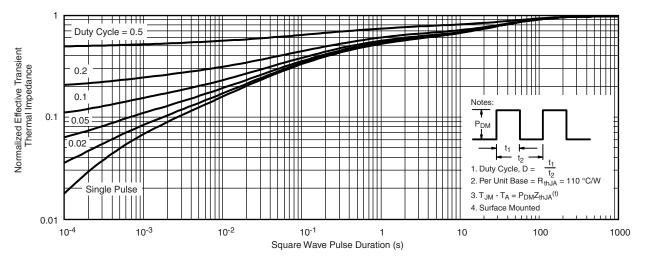


**Current Derating\*** 

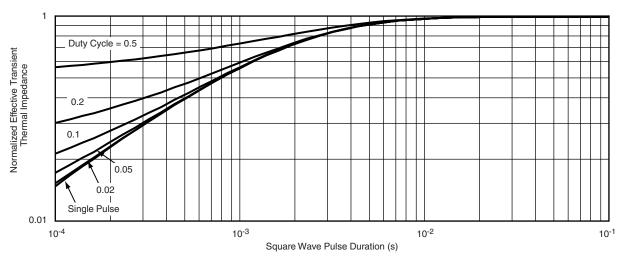
Power Derating

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

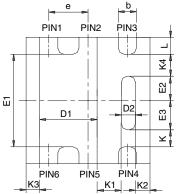
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg262929">www.vishay.com/ppg262929</a>.

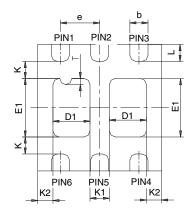




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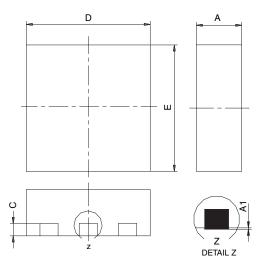
# PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
  Package outline exclusive of mold flash and metal burr
  Package outline inclusive of plating

	SINGLE PAD						DUAL PAD					
DIM	M	ILLIMETER	RS		INCHES		М	ILLIMETER	RS		INCHES	
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
<b>A</b> 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;	0.65 BSC		0.026 BSC			
K		0.275 TYP			0.011 TYP	1	0.275 TYP		0.011 TYP			
K1		0.400 TYP			0.016 TYP		0.320 TYP		0.013 TYP			
K2		0.240 TYP		0.009 TYP		0.252 TYP		0.010 TYP				
К3		0.225 TYP		0.009 TYP								
K4		0.355 TYP		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006
ECN: C O	C 07/21 Pay C 06 Aug 07											

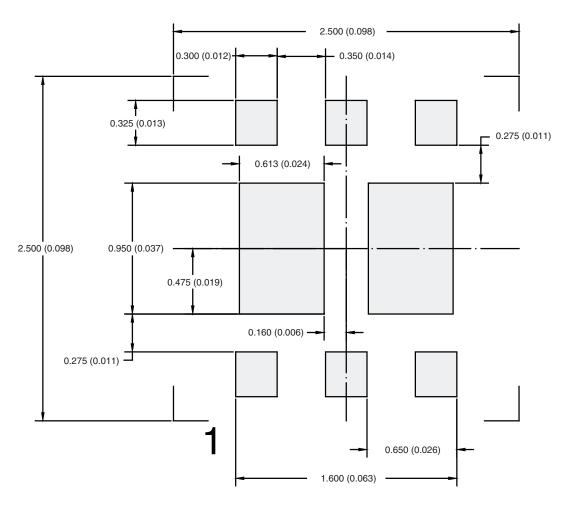
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

Document Number: 73001 06-Aug-07

# VISHAY.

#### RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

Return to Index



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Revision: 02-Oct-12 Document Number: 91000